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## **RF SPDT Switch MMIC**

## NSG1001MX, NSVG1001MX

This device is single pole dual throw (SPDT) type RF antenna switch MMIC. It has low insertion loss and high isolation. This is designed for wireless communication applications such as WLAN and V2X.

It adopts a small surface mount package and it is also suitable for portable devices such as smart phones and automotive antennas.

#### Features

- Broadband Frequency Range 0.1 to 8.5 GHz
- Capable of 1.6 V Operation
- Low Insertion Loss / High Isolation / Middle Power
- Small and Thin-sized Package 1.0 x 1.0 x 0.43 mm
- Wettable Flank Package for Optimal Automated Optical Inspection (AOI)
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- IEEE802.11 a/b/g/n/ac/ax WLAN, Bluetooth<sup>®</sup> Systems
- LTE & Wireless Communication Applications
- Automotive V2X and E-TOLL Applications

#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Control Voltage	V <sub>CTL</sub>	6	V
Input Power 5 V, CW	P <sub>in</sub>	30	dBm
Storage Temperature Range	T <sub>stg</sub>	–55 to +150	°C
Operating Temperature Range	T <sub>opr</sub>	-40 to +125	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

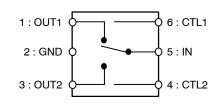
#### TRUTH TABLE

On Path	V <sub>CTL1</sub>	V <sub>CTL2</sub>	
IN – OUT1	Low	High	
IN – OUT2	High	Low	



XDFNW MX SUFFIX CASE 717AE

#### ELECTRICAL CONNECTION



#### MARKING DIAGRAM



AA = Specific Device Code M = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSG1001MXTAG	X2DFNW6 (Pb-Free)	3000 / Tape & Reel
NSVG1001MXTAG	X2DFNW6 (Pb-Free)	3000 / Tape & Reel

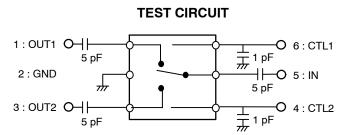
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### NSG1001MX, NSVG1001MX

Parameter	Symbol	Path	Condition	Value			
				Min	Тур	Max	Unit
Insertion Loss IL	IL	IN to OUT1, OUT2	f = 2.5 GHz		0.40	0.55	dB
			f = 6.0 GHz		0.50	0.65	
		f = 8.5 GHz		0.65	0.85		
Isolation ISL	ISL	IN to OUT1, OUT2	f = 2.5 GHz	28.0	31.0		dB
			f = 6.0 GHz	26.5	29.5		
			f = 8.5 GHz	17.0	20.0		
Return Loss RL		f = 2.5 GHz		25.0		dB	
			f = 6.0 GHz		20.0		
			f = 8.5 GHz		18.0		
0.1 dB Compression Input Power Pin 0.1 dB	Pin 0.1 dB	IN to OUT1, OUT2	f = 2.5 GHz	25.0	27.0		dBm
			f = 6.0 GHz	25.0	27.0		1
Switching Time		50% VCTL to 90/10% RF		1	100		ns
Switching Control Current	I <sub>CTL</sub>		No Signal		2.0	5.0	μA

#### ELECTRICAL CHARACTERISTICS at T<sub>A</sub> = 25°C Control Voltage: 0/+2.7 V, DC Blocking Capacitor 5.0 pF

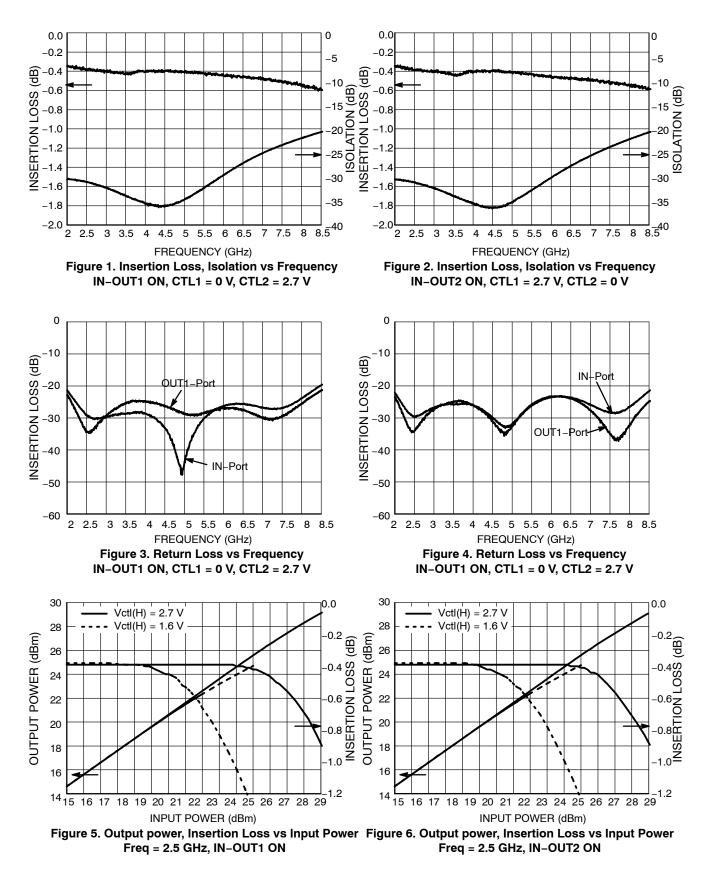
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pay attention to handling since it is liable to be affected by static electricity due to the high-frequency process adopted.



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#### NSG1001MX, NSVG1001MX

#### **ELECTRICAL CHARACTERISTICS**



#### NSG1001MX, NSVG1001MX

#### **ELECTRICAL CHARACTERISTICS**

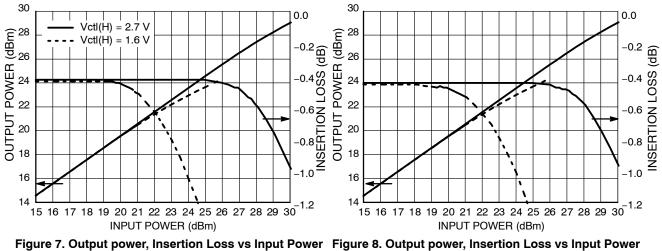


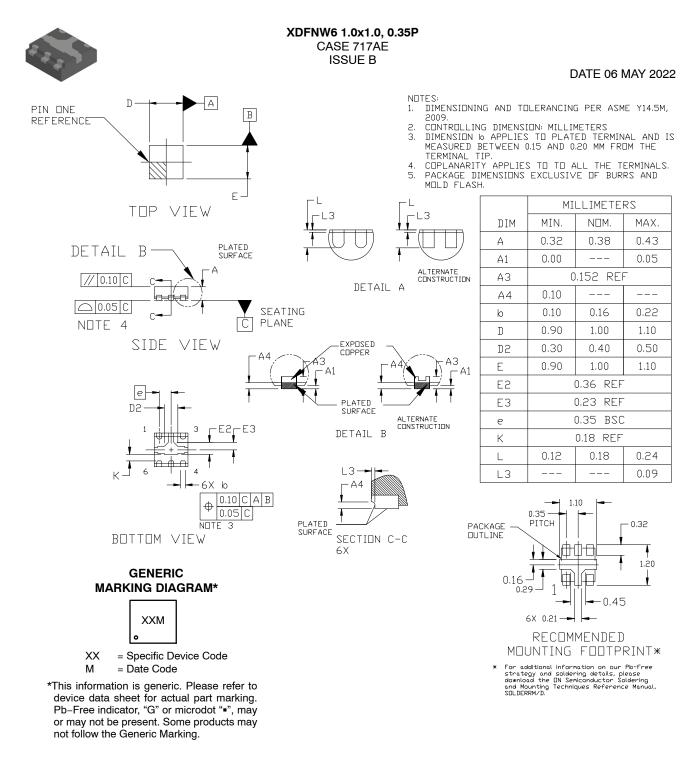
Figure 7. Output power, Insertion Loss vs Input Power Freq = 6.0 GHz, IN-OUT1 ON

gure 8. Output power, Insertion Loss vs Input Power Freq = 6.0 GHz, IN–OUT2 ON

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#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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